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AT-42070

Up to 6 GHz Medium Power Silicon Bipolar Transistor



Data Sheet

Description

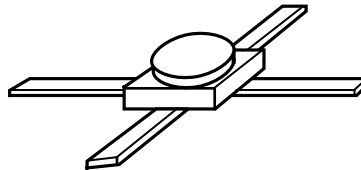
Avago's AT-42070 is a general purpose NPN bipolar transistor that offers excellent high frequency performance. The AT-42070 is housed in a hermetic, high reliability gold-ceramic 70 mil microstrip package. The 4 micron emitter-to-emitter pitch enables this transistor to be used in many different functions. The 20 emitter finger interdigitated geometry yields a medium sized transistor with impedances that are easy to match for low noise and medium power applications. This device is designed for use in low noise, wideband amplifier, mixer and oscillator applications in the VHF, UHF, and microwave frequencies. An optimum noise match near 50Ω up to 1 GHz, makes this device easy to use as a low noise amplifier.

The AT-42070 bipolar transistor is fabricated using Avago's 10 GHz f_T Self-Aligned-Transistor (SAT) process. The die is nitride passivated for surface protection. Excellent device uniformity, performance and reliability are produced by the use of ion-implantation, self-alignment techniques, and gold metalization in the fabrication of this device.

Features

- High Output Power:
 - 21.0 dBm Typical P1 dB at 2.0 GHz
 - 20.5 dBm Typical P1 dB at 4.0 GHz
- High Gain at 1 dB Compression:
 - 15.0 dB Typical G1 dB at 2.0 GHz
 - 10.0 dB Typical G1 dB at 4.0 GHz
- Low Noise Figure: 1.9 dB Typical NFO at 2.0 GHz
- High Gain-Bandwidth Product: 8.0 GHz Typical f_T
- Hermetic Gold-ceramic Microstrip Package

70 mil Package



AT-42070 Absolute Maximum Ratings

Symbol	Parameter	Units	Absolute Maximum ^[1]
V _{EBO}	Emitter-Base Voltage	V	1.5
V _{CB0}	Collector-Base Voltage	V	20
V _{CE0}	Collector-Emitter Voltage	V	12
I _C	Collector Current	mA	80
P _T	Power Dissipation ^[2,3]	mW	600
T _j	Junction Temperature	°C	200
T _{STG}	Storage Temperature	°C	-65 to 200

Thermal Resistance^[2,4]:

$$\theta_{jc} = 150^{\circ}\text{C}/\text{W}$$

Notes:

1. Permanent damage may occur if any of these limits are exceeded.
2. T_{case} = 25°C.
3. Derate at 6.7 mW/°C for T_c > 110°C.
4. The small spot size of this technique results in a higher, though more accurate determination of θ_{jc} than do alternate methods. See MEASUREMENTS section "Thermal Resistance" for more information.

Electrical Specifications, T_A = 25°C

Symbol	Parameters and Test Conditions ^[1]	Units	Min.	Typ.	Max.
S _{21E} ²	Insertion Power Gain; V _{CE} = 8 V, I _C = 35 mA	f = 2.0 GHz f = 4.0 GHz	10.5	11.5 5.5	
P _{1dB}	Power Output @ 1 dB Gain Compression V _{CE} = 8 V, I _C = 35 mA	f = 2.0 GHz f = 4.0 GHz		21.0 20.5	
G _{1dB}	1 dB Compressed Gain; V _{CE} = 8 V, I _C = 35 mA	f = 2.0 GHz f = 4.0 GHz		15.0 10.0	
NF ₀	Optimum Noise Figure: V _{CE} = 8 V, I _C = 10 mA	f = 2.0 GHz f = 4.0 GHz		1.9 3.0	
G _A	Gain @ NF ₀ ; V _{CE} = 8 V, I _C = 10 mA	f = 2.0 GHz f = 4.0 GHz		14.0 10.5	
f _T	Gain Bandwidth Product: V _{CE} = 8 V, I _C = 35 mA			8.0	
h _{FE}	Forward Current Transfer Ratio; V _{CE} = 8 V, I _C = 35 mA		30	150	270
I _{CB0}	Collector Cutoff Current; V _{CB} = 8 V				0.2
I _{EBO}	Emitter Cutoff Current; V _{EB} = 1 V				2.0
C _{CB}	Collector Base Capacitance ^[1] ; V _{CB} = 8 V, f = 1 MHz			0.28	

Note:

1. For this test, the emitter is grounded.

AT-42070 Typical Performance, $T_A = 25^\circ\text{C}$

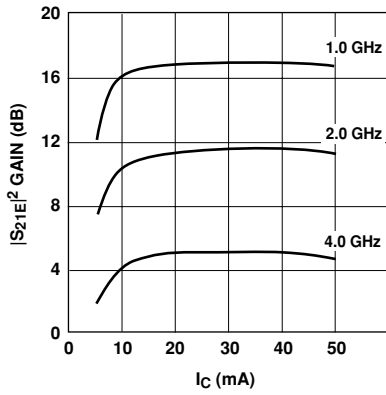


Figure 1. Insertion Power Gain vs. Collector Current and Frequency. $V_{CE} = 8\text{ V}$.

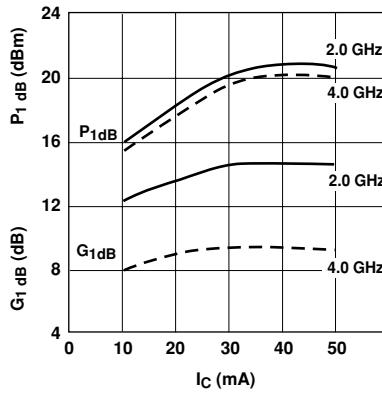


Figure 2. Output Power and 1 dB Compressed Gain vs. Collector Current and Frequency. $V_{CE} = 8\text{ V}$.

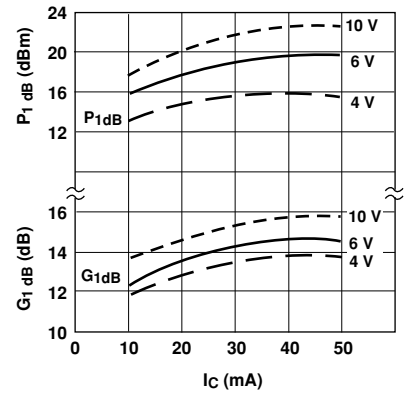


Figure 3. Output Power and 1 dB Compressed Gain vs. Collector Current and Voltage. $f = 2.0\text{ GHz}$.

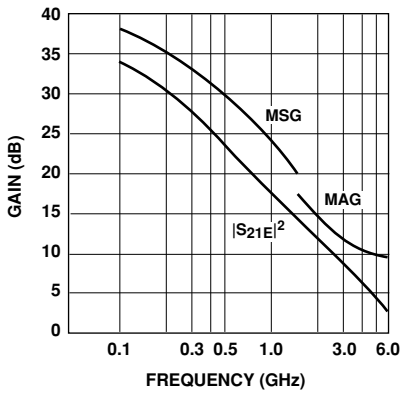


Figure 4. Insertion Power Gain, Maximum Available Gain and Maximum Stable Gain vs. Frequency. $V_{CE} = 8\text{ V}$, $I_C = 35\text{ mA}$.

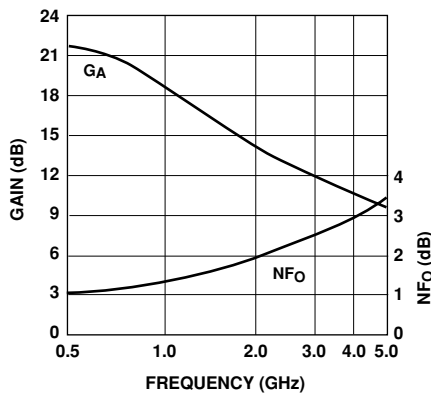


Figure 5. Noise Figure and Associated Gain vs. Frequency. $V_{CE} = 8\text{ V}$, $I_C = 10\text{ mA}$.

AT-42070 Typical Scattering Parameters,

Common Emitter, $Z_0 = 50 \Omega$, $T_A = 25^\circ\text{C}$, $V_{CE} = 8 \text{ V}$, $I_C = 10 \text{ mA}$

Freq. GHz	S_{11}		dB	S_{21}		dB	S_{12}		S_{22}	
	Mag.	Ang.		Mag.	Ang.		Mag.	Ang.	Mag.	Ang.
0.1	.70	-49	28.5	26.56	154	-36.0	.016	77	.91	-18
0.5	.69	-137	21.5	11.85	105	-29.6	.033	34	.50	-41
1.0	.69	-165	16.0	6.34	85	-27.2	.044	29	.40	-44
1.5	.68	-179	12.7	4.33	72	-27.4	.043	37	.38	-48
2.0	.69	169	10.3	3.26	62	-25.6	.052	42	.37	-54
2.5	.69	164	8.5	2.64	56	-25.4	.054	46	.37	-55
3.0	.70	157	6.9	2.22	48	-23.8	.065	52	.39	-63
3.5	.70	151	5.6	1.91	39	-22.4	.076	51	.41	-71
4.0	.69	144	4.5	1.68	30	-21.4	.085	55	.43	-77
4.5	.68	137	3.5	1.50	22	-20.4	.096	49	.46	-83
5.0	.68	128	2.7	1.37	14	-19.4	.107	50	.48	-87
5.5	.68	117	2.0	1.26	5	-18.3	.121	45	.48	-91
6.0	.70	107	1.2	1.15	-3	-17.6	.132	44	.48	-98

AT-42070 Typical Scattering Parameters,

Common Emitter, $Z_0 = 50 \Omega$, $T_A = 25^\circ\text{C}$, $V_{CE} = 8 \text{ V}$, $I_C = 35 \text{ mA}$

Freq. GHz	S_{11}		dB	S_{21}		dB	S_{12}		S_{22}	
	Mag.	Ang.		Mag.	Ang.		Mag.	Ang.	Mag.	Ang.
0.1	.52	-95	33.4	46.52	139	-40.0	.010	50	.77	-29
0.5	.66	-163	23.1	14.33	95	-34.4	.019	46	.34	-42
1.0	.67	179	17.3	7.36	80	-29.6	.033	51	.28	-41
1.5	.67	169	13.9	4.97	69	-28.0	.040	59	.27	-44
2.0	.68	160	11.4	3.74	60	-27.3	.053	59	.27	-51
2.5	.69	157	9.6	3.04	55	-23.8	.065	65	.28	-53
3.0	.69	151	8.1	2.55	47	-22.8	.072	65	.28	-62
3.5	.69	145	6.8	2.20	39	-21.4	.086	59	.30	-72
4.0	.68	139	5.7	1.93	20	-20.2	.097	60	.33	-80
4.5	.67	132	4.7	1.74	22	-19.3	.109	54	.36	-85
5.0	.67	123	4.0	1.59	13	-18.0	.126	50	.38	-90
5.5	.67	113	3.2	1.46	5	-17.2	.138	46	.39	-94
6.0	.69	103	2.5	1.34	-4	-16.4	.152	40	.38	-102

A model for this device is available in the DEVICE MODELS section.

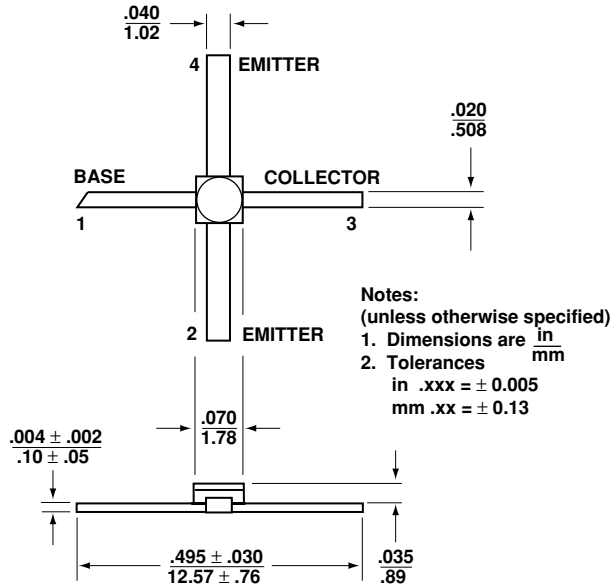
AT-42070 Noise Parameters: $V_{CE} = 8 \text{ V}$, $I_C = 10 \text{ mA}$

Freq. GHz	NF_0 dB	Γ_{opt}		$R_N/50$
		Mag	Ang	
0.1	1.0	.05	15	0.13
0.5	1.1	.06	75	0.13
1.0	1.5	.10	126	0.12
2.0	1.9	.23	172	0.11
4.0	3.0	.45	-145	0.17

Ordering Information

Part Number	No. of Devices
AT-42070	100

70 mil Package Dimensions



For product information and a complete list of distributors, please go to our web site: www.avagotech.com

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